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Fairchild Semiconductor FDP030N06

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FAIRCHILD

SEMICONDUCTOR

FDP030N06 N-Channel PowerTrench[®] MOSFET 60 V, 193 A, 3.2 mΩ

Features

- $R_{DS(on)}$ = 2.6 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 75 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

November 2013

FDP030N06 — N-Channel PowerTrench[®] MOSFET

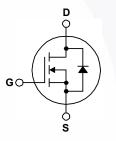
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Renewable system





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter	FDP030N06	Unit	
V _{DSS}	Drain to Source Voltage		60	V	
V _{GSS}	Gate to Source Voltage	±20	V		
		- Continuous (T _C = 25°C, Silicon Limited)	193		
I _D	Drain Current	- Continuous (T _C = 100 ^o C, Silicon Limited)	136	A	
		- Continuous (T _C = 25°C, Package Limited)	120		
I _{DM}	Drain Current	- Pulsed (Note 1)	772	A	
E _{AS}	Single Pulsed Avalanche	Energy (Note 2)	1434	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note		6.0	V/ns	
п	Dower Dissinction	(T _C = 25°C)	231	W	
P _D	Power Dissipation	- Derate above 25°C	1.54	W/ºC	
T _J , T _{STG}	Operating and Storage To	-55 to +175	°C		
TL	Maximum Lead Tempera	300	°C		

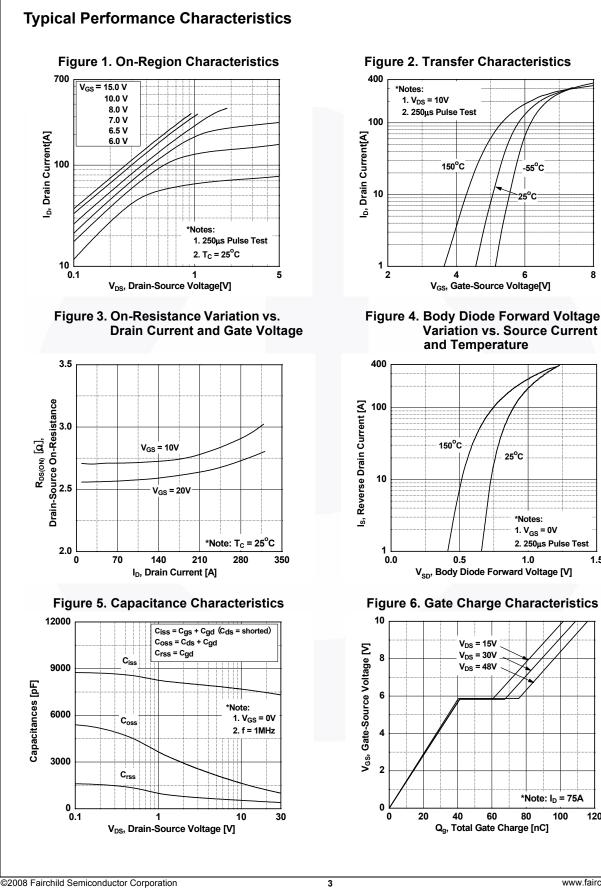
Thermal Characteristics

Symbol	Parameter	FDP030N06	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.65	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W	



Part Number FDP030N06		Top Mark	Top Mark Packa		Packing Method	Reel Size)	Tape Width	Qua	antity
		FDP030N06	TO-2	220	Tube	N/A		N/A	50 units	
Electrica	l Chara	acteristics T _C = 2	25 ⁰ C unles	es othe	nwise noted		·			
Symbol		Parameter			Test Conditions	S	Min.	Тур.	Max.	Unit
Off Charac	teristics	6				L. L				
BV _{DSS}	Drain to	Drain to Source Breakdown Voltage		I _D = 250 μA, V _{GS} = 0 V, T _C = 25 ^o C				-	-	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient		re	$I_D = 1$ mA, Referenced to $25^{\circ}C$			-	0.05	-	V/ºC
I _{DSS}	Zero Gate Voltage Drain Current			$V_{DS} = 48 V, V_{GS} = 0 V$ $V_{DS} = 48 V, T_{C} = 150^{\circ}C$			-	-	1 500	μA
I _{GSS}	Gate to Body Leakage Current			$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			-	-	±100	nA
On Charac										
V _{GS(th)}	Gate Th	reshold Voltage		VGS	= V _{DS} , I _D = 250 μA		2.5	3.5	4.5	V
R _{DS(on)}		ain to Source On Resis	stance		= 10 V, I _D = 75 A		-	2.6	3.2	mΩ
9FS	Forward	Transconductance		$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 75 \text{ A}$			-	154	-	S
Dynamic C	haracte	ristics								
C _{iss}	1	pacitance					-	7380	9815	pF
C _{oss}		apacitance			= 25 V, V _{GS} = 0 V, MHz		-	1095	1455	pF
C _{rss}	Reverse	Transfer Capacitance			INITIZ		-	415	625	pF
Q _{g(tot)}	Total Ga	te Charge at 10V		Vne	= 48 V, I _D = 75 A,		-	116	151	nC
Q _{gs}	Gate to S	Source Gate Charge		V _{GS} = 10 V			-	40	-	nC
Q _{gd}	Gate to I	Drain "Miller" Charge				(Note 4)	-	35	-	nC
Switching	Charact	eristics								
t _{d(on)}	Turn-On	Delay Time					-	39	87	ns
t _r	Turn-On	Rise Time			V _{DD} = 30 V, I _D = 75 A,		-	178	366	ns
t _{d(off)}	Turn-Off Delay Time			V_{GS} = 10 V, R_{G} = 4.7 Ω		-	54	118	ns	
t _f	Turn-Off	Fall Time				(Note 4)	-	33	76	ns
Drain-Sou	rce Diod	e Characteristics								
I _S	Maximun	n Continuous Drain to S	Source Dic	ode Fo	rward Current		/-	-	193	Α
I _{SM}	Maximun	n Pulsed Drain to Source	ce Diode F	Forward Current			-	-	772	Α
V _{SD}	Drain to	Drain to Source Diode Forward Voltage		V _{GS} = 0 V, I _{SD} = 75 A			-	-	1.3	V
t _{rr}	Reverse Recovery Time			$V_{GS} = 0 V, I_{SD} = 75 A,$			-	46		ns
Q _{rr}	Reverse	Recovery Charge		dI _F /c	t = 100 A/μs		-	50		nC
2. L = 0.51 mH, I _A 3. I _{SD} \leq 75 A, di/d	_{.S} = 75 A, V _{DD} t ≤ 450 A/μs, V	limited by maximum junction te = 50 V, R _G = 25 Ω , starting T _J $_{DD} \leq BV_{DSS}$, starting T _J = 25°(erating temperature typical cha	= 25°C. C.							





FDP030N06 Rev. C2

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120

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-55°C

8

25°C

6

*Notes:

1.0

1. V_{GS} = 0V

2. 250µs Pulse Test

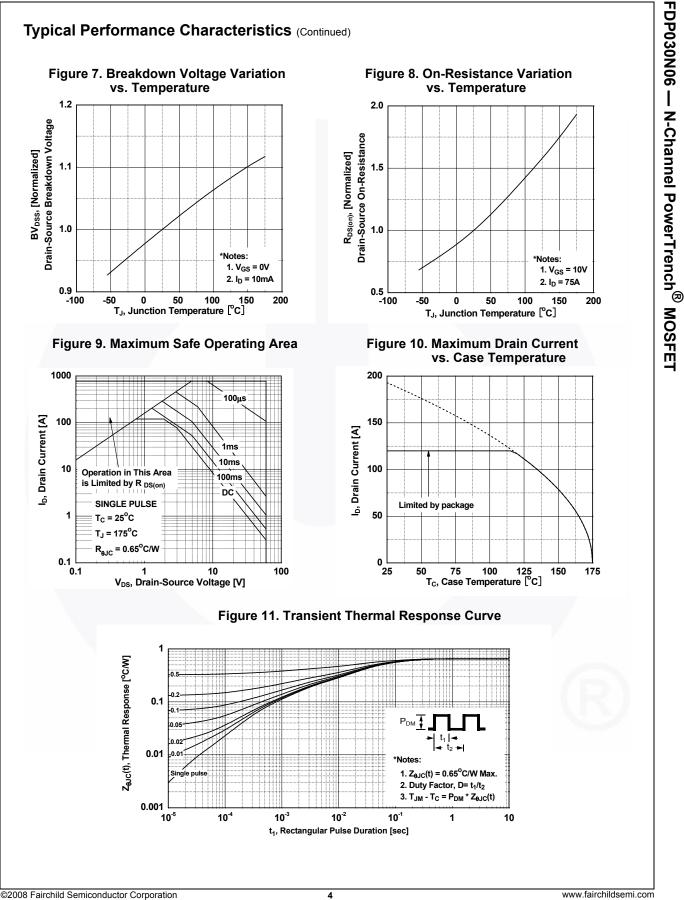
*Note: I_D = 75A

100

80

1.5



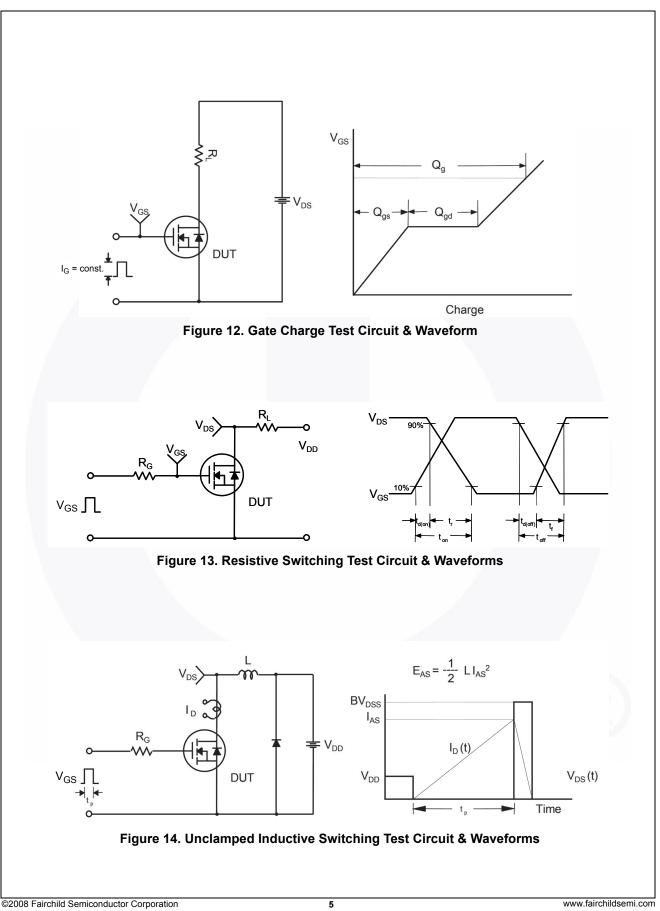


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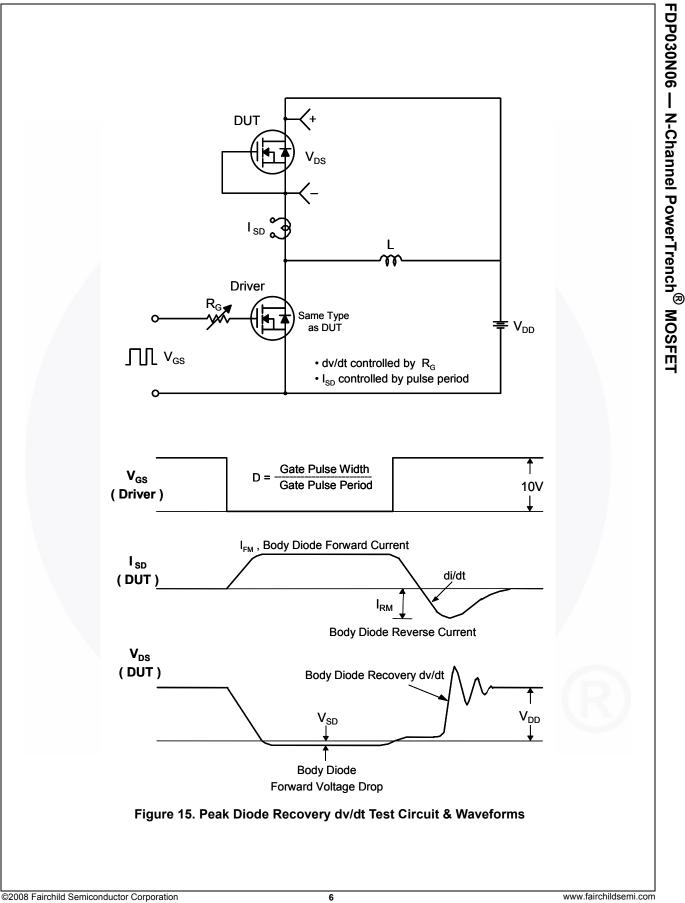


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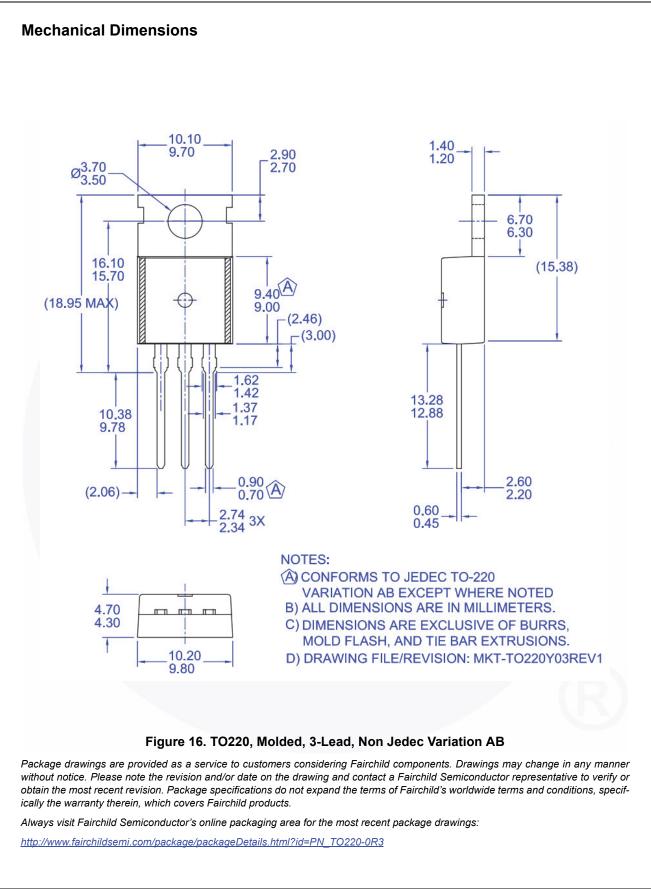








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Rev 166

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